Technical Data 4071

Effective June 2017 Supersedes July 2010

MLVB Multilayer varistor ESD suppressor



BUSSMANN



Surface Mount Device

Product features

- Zinc oxide based ceramic chip
- Low capacitance to meet the need for high speed transient voltage protection
- Provides ESD protection with fast response time (<1ns) allowing equipment to pass IEC 61000-4-2 Level 4 Test
- Low profile designs for board space savings
- Low and stable leakage current reduces power consumption
- Low clamping voltage
- Lead free, halogen free and RoHS compliant for global applications

Applications

- Computers and peripherals
- Digital cameras
- Mobile phones
- Medical equipment
- DVD Players
- MP3/Multimedia players
- LCD TV / Monitor
- External storage
- Cable/DSL Modems
- USB 2.0
- Set top boxes

	<u>MLVB</u>	04	<u>V18</u>	<u>C001</u>
Product Family				
Size				
Working DC Voltage				
Capacitance in pF*				

* Part numbers use "R" to denote decimal point for decimal values of pico farads.

Packaging

- Size 0402: 10,000 pieces per reel EIA (EIAJ)
- Size 0603: 4000 pieces per reel EIA (EIAJ)

Specifications							
Part Number	Size	Working Voltage (Vdc)	Varistor Voltage @1mAdc	Clamping Voltage	Capacitance pF	Leakage Current (µA)	
MLVB04V18C0R5	0402	18	90-120	250*	0.5	<10	
MLVB04V18C001	0402	18	46-60	110*	1	<10	
MLVB04V18C003	0402	18	22-34	58	3	<10	
MLVB04V09C005	0402	9	11-17	35	5	<10	
MLVB06V18C0R5	0603	18	90-120	250*	0.5	<10	
MLVB06V18C001	0603	18	46-60	110*	1	<10	
MLVB06V18C003	0603	18	22-34	58	3	<10	
MLVB06V09C005	0603	9	11-17	35	5	<10	

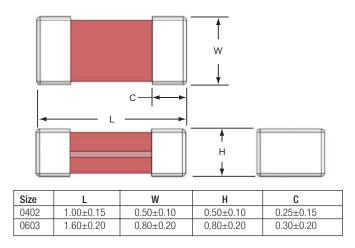
* Maximum peak voltage across the varistor with 8/20µs waveform and 0.5A pulse current. Working Voltage (Vdc) - Maximum DC operating voltage the varistor can maintain and not exceed 10µA leakage current.

Varistor Voltage - Voltage across the device measured at 1mA DC current. Equivalent to $V_B,$ "breakdown voltage." Clamping Voltage - Maximum peak voltage across the varistor with 8/20 μ s waveform and 1A pulse current.

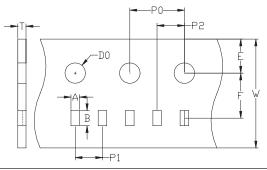
Capacitance - Device capacitance measured with zero volt bias $1 V_{\mbox{rms}}$ at 1MHz.



Dimensions - mm

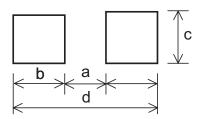


Tape Packaging Specifications - mm



0402 Carrier Dimensions									
Α	В	W	E	F	P0	P1	P2	D0	Т
0.58 ±0.03	1.2 ±0.03	8.0 ±0.1	1.75 ±0.05	3.5 ±0.05	4.0 ±0.1	2.0 ±0.05	2.0 ±0.05	1.55 ±0.05	0.60 ±0.03
0603 Carrier Dimensions									
0.90 ±0.20	1.80 ±0.20	8.0 ±0.30	1.75 ±0.10	3.50 ±0.05	4.00 ±0.10	-	2.00 ±0.05	1.50 ±0.10	-

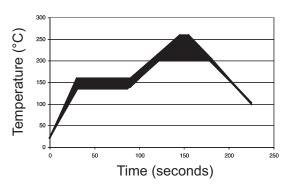
Recommended Pad Layout - mm (in)



Size	а	b	C	d
0402	0.51 (0.020)	0.61 (0.024)	0.51 (0.020)	1.70 (0.067)
0603	0.50 (0.020)	1.02 (0.040)	0.76 (0.030)	2.54 (0.100)

Soldering Recommendations

- · Compatible with lead and lead-free solder reflow processes
- Peak reflow temperatures and durations:
 - IR Reflow = 260° C max for 30 sec. max.
- Wave Solder = 260° C max. for 10 sec. max.
- Recommended IR Reflow Profile:



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